SPECIFICATION FOR LCD MODULE

Customer Approval:		

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)	Khan.wan	2009-12-09
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DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
01	2009-12-09	New desgin	Khan.wan

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1. Features & Mechanical Specifications

Item	Contents	Unit
	LCD	
LCD Type	TFT Transmissive Normal White	
Viewing direction	12:00	
Backlight	White LED x4 in parallel	
Interface	8/16bit parallel bus 8080- interface	
Driver IC	OTM3225A	
Outline Dimension	42.72(W) × 60.26 (H) ×3.7(T)	mm
Glass area (W×H×T)	40.58 ×56.96 × 1.0	mm
Active area (W×H)	36.72 × 48.96	mm
Number of Dots	240(RGB) × 320	
Dot pitch (W×H)	0.051 × 0.153	mm
Pixel pitch (W×H)	0.153 × 0.153	mm
Operating Temperature	-20 ∼ +70	$^{\circ}$ C
Storage temperature	-30 ∼ +80	$^{\circ}$ C

2. **Dimensional Outline**

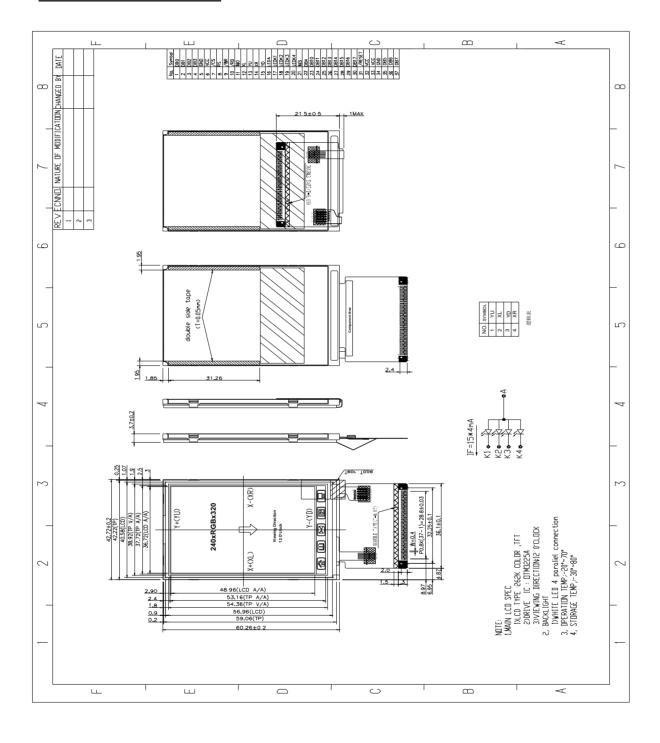


Figure 1. Dimensional outline

3. Block Diagram

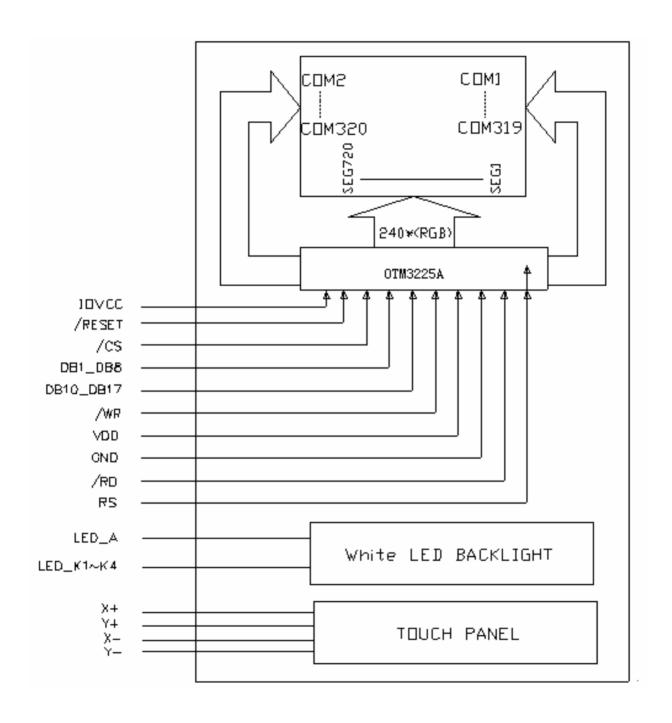


Figure 2. Block diagram

4. Pin Description

. Pin Description						
PIN No.	SYMBOL	Function				
1	DB0					
2	DB1	Data has				
3	DB2	Data bus				
4	DB3					
5	GND	System Ground				
6	VCC	Power supply				
7	/CS	Chip Select input pin. (Active Low)				
8	RS	Data or command select pin. "H": Date, "L": Command.				
9	/WR	Write signal input pin. (Active Low)				
10	/RD	Read signal input pin. (Active Low)				
11	IM0	IM0=0, Select 16bit interface; IM0=1,Select 8bit interface				
12	XL					
13	YU	Touch penal output pine				
14	XR	Touch panel output pins				
15	YD					
16	LEDA	Backlight LED Anode.				
17	LEDK1					
18	LEDK2	Backlight LED Cathode.				
19	LEDK3	9				
20	LEDK4					
21	IM3	NC				
22	DB4					
23	DB10					
24	DB11					
25	DB12					
26	DB13	Data bus				
27	DB14					
28	DB15					
29	DB16					
30	DB17					

31	/RESET	Reset Signal pin ("Low" is enable)			
32	VCC	Downer overally			
33	VCC	Power supply			
34	GND	System Ground			
35	DB5				
36	DB6	Data bus			
37	DB7				

Note:

R1	R2	R3	Interface Mode					
NC	Short	NC	8080-8bit interface: DB17~DB10					
Short	NC	NC	8080-16bit interface: DB17~DB10 , DB8~DB1					
NC	NC	Short	IM0=0, Select 16bit interface; IM0=1,Select 8bit interface					

5. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply Voltage range	VDD	-0.3 to +3.7	V
Operating Temperature range	Тор	-20 to +70	$^{\circ}$ C
Storage Temperature range	Tst	-30 to +80	$^{\circ}$ C

6. Electrical Characteristics

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VCC	2.45	-	3.3	V

7. Backlight Characteristics

White LED \times 4 in parallel

 $(Ta = 25^{\circ}C)$

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=60mA	2.9	3.2	3.4	V
Uniformity	△Bp	-	80	-	ı	%
Luminance for LCD	Lv	IF=20	3200	3500	3800	cd/m ²

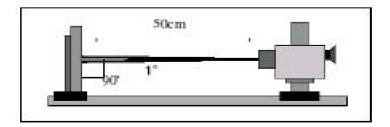
8. Electro-Optical Characteristics
Using CMO LC+ Normal Polarizer+Corresponding Backlight, reference only (Note 1-7)

lte m	8	Symbol	Condition	Min.	Тур.	Max	Unit	Remark
Response Time	Rise	Tr	8-0°	4	15	25	ms	Note 4, 6
Hesponse Time	Fall	Tf	0-0	96	20	30	Imes-	14010 4, 0
Contrast F (with HC polari		CR	At optimized viewing angle	200	300	55	8	Note 5, 6
NTSC		%		50	55			
	Тор		į	40	50	(46)		
ne e e e	Bottom	19441	CR≥ 10	15	20			2010-2
Viewing Angle	Left	0	GHZ IU	40	45	23	deg.	Note 7
	Right			40	45		8	
Transmittz (without pol				15	15.5	5	%	Typ. 6.2% with HC polarizer only
59	Wx			0.27	0.31	0.35		
	Wy			0.314	0.354	0.394	202	
	Rx			0.604	0.644	0.684		Measured
	Fly		8-0°	0.287	0.327	0.367	3	by C
Chromaticity	Gx		D=0~	0.258 0.298 0.338	8	Light		
	Gy		į.	0.53	0.57	0.61		source
	Bx			0.112	0.152	0.192	54	
	By		Î	0.149	0.189	0.229		

Note 1: Ambient temperature =25 C ±2 C.

Note 2: To be measured in the dark room with backlight unit.

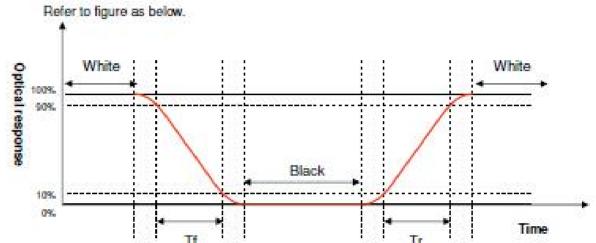
Note 3: To be measured at the center area of panel with a viewing cone of 1 by Topcon luminance meter BM-7, after 10 minutes operation (module).



Note 4: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (rising time) and from "white" to "black" (falling time), respectively.

The response time is defined as the time interval between the 10% and 90% of amplitudes.



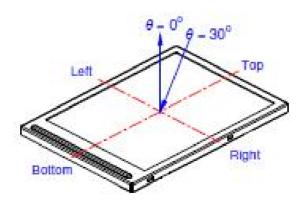
Note 5. Definition of contrast ratio:

Contrast ratio is calculated with the following formula:

Contrast ratio (CR)- Photo detector output when LCD is at "White" state
Photo detector output when LCD is at "Black

Note 6. White Vi-5.5V / Black Vj-0.9V

Note 7. Definition of viewing angle



9. Instruction Description System Function command List (1)

	Sterri Function (-				,	•,												
No.	Registers Name	R/W	RS	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
IR	Index Register	W	0		٠			-			-	ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
SR	Status Read	R	0	L7	Lβ	L5	L4	L3	L2	L1	L0	0	0	0	0	0	0	0	0
00h	Driver Code Read	R	1	1	0	0	1	0	0	1	0	0	0	1	0	0	0	1	0
00h	Start Oscillation	W	1					-	-				-			-	-	-	OSC
01h	Driver Output Control 1	W	1	0	0	0	0	0	SM	0	SS	0	0	0	0	0	0	0	0
02h	LCD Driving Control	W	1	0	0	0	0	0	1	B/C	EOR	0	0	0	0	0	0	0	0
03h	Entry Mode	W	1	TRI	DFM	0	BGR	0	0	HWM	0	ORG	0	I/D1	I/D0	AM	0	0	0
04h	Resize Control	W	1	0	0	0	0	0	0	RCV1	RCV0	0	0	RCH1	RCH0	0	0	RSZ1	RSZ0
07h	Display Control 1	W	1	0	0	PTDE1	PTDE0	0	0	0	BASEE	0	0	GON	DTE	CL	0	D1	D0
08h	Display Control 2	W	1	0	0	0	0	FP3	FP2	FP1	FP0	0	0	0	0	BP3	BP2	BP1	BP0
09h	Display Control 3	W	1	0	0	0	0	0	PTS2	PTS1	PTS0	0	0	PTG1	PTG0	ISC3	ISC2	ISC1	ISC0
0Ah	Display Control 4	W	1	0	0	0	0	0	0	0	0	0	0	0	0	FMARKOE	FMI2	FMI1	FMI0
0Ch	RGB Display Interface Control 1	W	1	ENC2	ENC1	ENC0	0	0	0	0	RM	0	0	DM1	DM0	0	0	RIM1	RIM0
0Dh	Frame Maker Position	W	1	0	0	0	0	0	0	0	FMP8	FMP7	FMP6	FMP5	FMP4	FMP3	FMP2	FMP1	FMP0
0Fh	RGB Display Interface Control 2	W	1	0	0	0	0	0	0	0	0	0	0	0	VSPL	HSPL	0	DPL	EPL
10h	Power Control 1	W	1	0	0	0	SAP	BT3	BT2	BT1	BT0	APE	AP2	AP1	AP0	0	DSTB	SLP	0
11h	Power Control 2	W	1	0	0	0	0	0	DC12	DC11	DC10	0	DC02	DC01	DC00	0	VC2	VC1	VCO
12h	Power Control 3	W	1	0	0	0	0	0	0	0	VCMR	0	0	0	PON	VRH3	VRH2	VRH1	VRH0
13h	Power Control 4	W	1	0	0	0	VDV4	VDV3	VDV2	VDV1	VDV0	0	0	0	0	0	0	0	0
20h	Horizontal GRAM Address Set	W	1	0	0	0	0	0	0	0	0	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
21h	Vertical GRAM Address Set	W	1	0	0	0	0	0	0	0	AD16	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8
22h	Write Data to GRAM	W	1	RAM w	rite data	a (WD17-0) / read dat	ta (RD17-0) bits are t	ransferred	via differe	nt data bus	lines acc	ording to th	ne selected	interfaces.			
29h	Power Control 7	W	1	0	0	0	0	0	0	0	0	0	0	0	VCM4	VCM3	VCM2	VCM1	VCMO
2Bh	Frame Rate and Color Control	W	1	0	0	0	0	0	0	0	0	EXT R	0	FR SEL1	FR SELO	0	0	0	0
30h	Gamma Control 1	W	1	0	0	0	0	0	KP1[2]	KP1[1]	KP1[0]	0	0	0	0	0	KP0[2]	KP0[1]	KP0[0]
31h	Gamma Control 2	W	1	0	0	0	0	0	KP3[2]	KP3[1]	KP3[0]	0	0	0	0	0	KP2[2]	KP2[1]	KP2[0]
32h	Gamma Control 3	W	1	0	0	0	0	0	KP5[2]	KP5[1]	KP5[0]	0	0	0	0	0	KP4[2]	KP4[1]	KP4[0]
35h	Gamma Control 4	W	1	0	0	0	0	0	RP1[2]	RP1[1]	RP1[0]	0	0	0	0	0	RP0[2]	RP0[1]	RP0[0]
36h	Gamma Control 5	W	1	0	0	0	VRP1[4]	VRP1[3]	VRP1[2]	VRP1[1]	VRP1[0]	0	0	0	VRP0[4]	VRP0[3]	VRP0[2]	VRP0[1]	VRP0[0]
37h	Gamma Control 6	W	1	0	0	0	0	0	KN1[2]	KN1[1]	KN1[0]	0	0	0	0	0	KN0[2]	KN0[1]	KN0[0]
38h	Gamma Control 7	W	1	0	0	0	0	0	KN3[2]	KN3[1]	KN3[0]	0	0	0	0	0	KN2[2]	KN2[1]	KN2[0]
39h	Gamma Control 8	W	1	0	0	0	0	0	KN5[2]	KN5[1]	KN5[0]	0	0	0	0	0	KN4[2]	KN4[1]	KN4[0]
3Ch	Gamma Control 9	W	1	0	0	0	0	0	RN1[2]	RN1[1]	RN1[0]	0	0	0	0	0	RN0[2]	RN0[1]	RN0[0]

System Function command List (2)

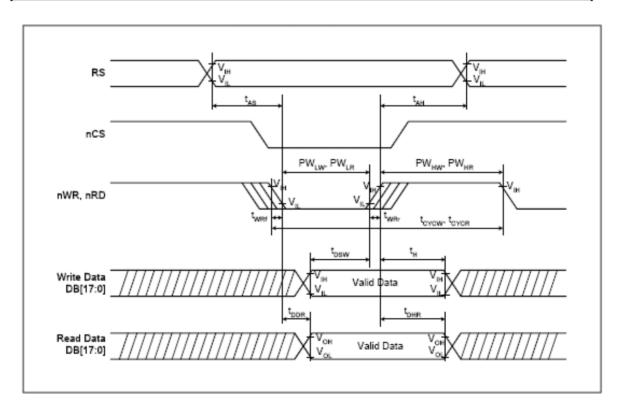
					_							_							
No.	Registers Name	R/W	RS	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
3Dh	Gamma Control 10	W	1	0	0	0	VRN1[4]	VRN1[3]	VRN1[2]	VRN1[1]	VRN1[0]	0	0	0	VRN0[4]	VRN0[3]	VRN0[2]	VRN0[1]	VRN0[0]
50h	Horizontal Address Start Position	W	1	0	0	0	0	0	0	0	0	HSA7	HSA6	HSA5	HSA4	HSA3	HSA2	HSA1	HSA0
51h	Horizontal Address End Position	W	1	0	0	0	0	0	0	0	0	HEA7	HEA6	HEA5	HEA4	HEA3	HEA2	HEA1	HEA0
52h	Vertical Address Start Position	W	1	0	0	0	0	0	0	0	VSA8	VSA7	VSA6	VSA5	VSA4	VSA3	VSA2	VSA1	VSAO
53h	Vertical Address End Position	W	1	0	0	0	0	0	0	0	VEA8	VEA7	VEA6	VEA5	VEA4	VEA3	VEA2	VEA1	VEA0
60h	Driver Output Control 2	W	1	GS	0	NL5	NL4	NL3	NL2	NL1	NLO	0	0	SCN5	SCN4	SCN3	SCN2	SCN1	SCN0
61h	Base Image Display Control	W	1	0	0	0	0	0	0	0	0	0	0	0	0	0	NDL	VLE	REV
6Ah	Vertical Scroll Control	W	1	0	0	0	0	0	0	0	VL8	VL7	VL6	VL5	VL4	VL3	VL2	VL1	VL0
80h	Partial Image 1 Display Position	W	1	0	0	0	0	0	0	0	PTDP08	PTDP07	PTDP06	PTDP05	PTDP04	PTDP03	PTDP02	PTDP01	PTDP00
81h	Partial Image 1 Area (Start Line)	W	1	0	0	0	0	0	0	0	PTSA08	PTSA07	PTSA06	PTSA05	PTSA04	PTSA03	PTSA02	PTSA01	PTSA00
82h	Partial Image 1 Area (End Line)	W	1	0	0	0	0	0	0	0	PTEA08	PTEA07	PTEA06	PTEA05	PTEA04	PTEA03	PTEA02	PTEA01	PTEA00
83h	Partial Image 2 Display Position	W	1	0	0	0	0	0	0	0	PTDP18	PTDP17	PTDP16	PTDP15	PTDP14	PTDP13	PTDP12	PTDP11	PTDP10
84h	Partial Image 2 Area (Start Line)	W	1	0	0	0	0	0	0	0	PTSA18	PTSA17	PTSA16	PTSA15	PTSA14	PTSA13	PTSA12	PTSA11	PTSA10
85h	Partial Image 2 Area (End Line)	W	1	0	0	0	0	0	0	0	PTEA18	PTEA17	PTEA16	PTEA15	PTEA14	PTEA13	PTEA12	PTEA11	PTEA10
90h	Panel Interface Control 1	W	1	0	0	0	0	0	0	DIVI1	DIVI00	0	0	0	0	RTNI3	RTNI2	RTNI1	RTNI0
92h	Panel Interface Control 2	W	1	0	0	0	0	0	NOWI2	NOWI1	NOWIO	0	0	0	0	0	0	0	0
93h	Panel Interface Control 3	W	1	0	0	0	0	0	0	0	0	0	0	0	0	0	MCPI2	MCPI1	MCP10
95h	Panel Interface Control 4	W	1	0	0	0	0	0	0	DIVE1	DIVE0	0	0	RTNE5	RTNE4	RTNE3	RTNE2	RTNE1	RTNE0
97h	Panel Interface Control 5	W	1	0	0	0	0	NOWE3	NOWE2	NOWE1	NOWE0	0	0	0	0	0	0	0	0
98h	Panel Interface Control 6	W	1	0	0	0	0	0	0	0	0	0	0	0	0	0	MCPE2	MCPE1	MCPE0

10. AC Characteristics

8080-series MCU interface Timing Characteristics

Normal Write Mode (IOVCC = 1.65~3.3V, VCC=2.4~3.3V)

	ltem	Symbol	Unit	Min.	Тур.	Max.	Test Condition
Dece accele times	Write	toyow	ns	100	-	-	-
Bus cycle time	Read	tcyce	ns	300	-	-	-
Write low-level pu	PWLW	ns	50	-	500	-	
Write high-level p	ulse width	PW _{HW}	ns	50	-	-	-
Read low-level pu	lse width	PWLR	ns	150	-	-	-
Read high-level pe	PW _{HR}	ns	150	-	-		
Write / Read rise /	fall time	twe/twe	ns	-	-	25	
Catum times	Write (RS to nCS, E/nWR)	tas	ns	10	-	-	
Setup time	Read (RS to nCS, RW/nRD)			5	-	-	
Address hold time	•	tan	ns	5	-	-	
Write data set up	time	tosw	ns	10	-	-	
Write data hold tir	tн	ns	15	-	-		
Read data delay ti	topa	ns	-	-	100		
Read data hold tin	ne	tohr	ns	5	-	-	



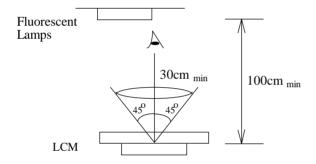
11.Quality Specifications

All The raw material are Rohs complicant.

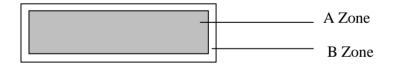
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area

11.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		-
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	

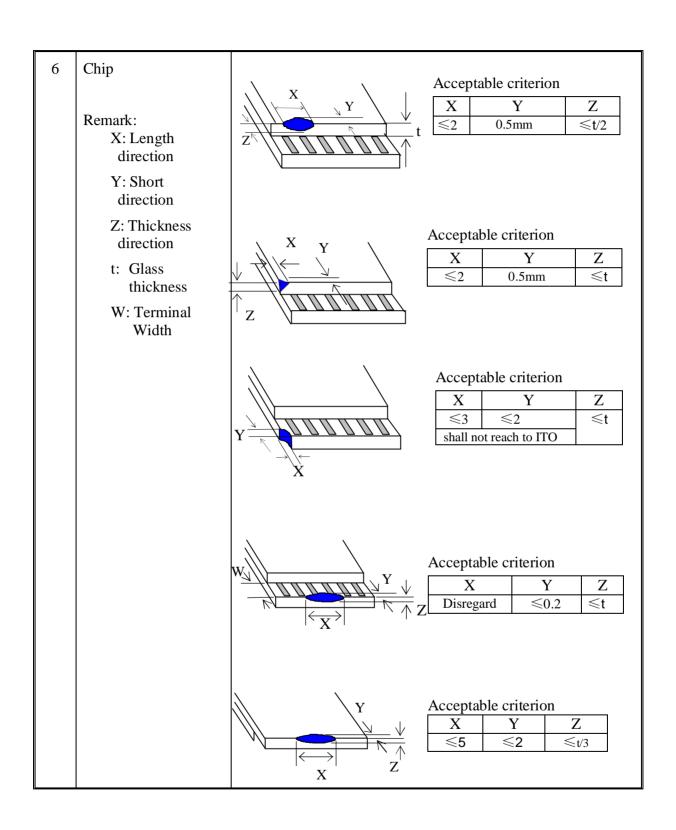
TAB	Position, Bonding strength	13		
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Note on defect classification

No.	Item		Criterion				
1	Short or open circuit		Not allow				
	LC leakage						
	Flickering						
	No display						
	Wrong viewing direction						
	Wrong Back-light						
2	Contrast defect	Refer to approval sample					
	Background color deviation						
3	Point defect, Black spot, dust	ÛŢĀ	Point Size	Acceptable Qty.			
	(including Polarizer)	$\overset{ \longleftrightarrow }{X}$	φ <u><</u> 0.10	Disregard			
			0.10<♦≤0.15	2			
	1 (37.37)/0		0.15<∮≤0.20	2			
	$\phi = (X+Y)/2$		ф>0.20	0			
		U	nit: mm				

4	Line defect,	$\longrightarrow \stackrel{\downarrow}{\longrightarrow} W$					
				Line	Acceptable Qty.		
	Scratch	$\left \longleftrightarrow\right $	L	W			
		L		0.015≥W	Disregard		
			3.0≥L	0.03≥W	2		
			2.0≥L	0.05≥W	2		
			1.0≥L	0.1>W	1		
				0.05 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect		
			Unit: mm				
5	Rainbow	Not more than two color changes across the viewing area.					

	No	Item	Criterion
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No.	Item	Criterion					
7	Segment pattern $W = Segment \ width$ $\phi = (X+Y)/2$	(1) Pin hole φ < 0.10mm is acceptable.					
		Point Size Acceptable Qty					
8	Back-light	(1) The color of backlight should correspond its specification.					
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead					
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable. 					
11*	PCB	(4) Not allow exposed copper wire inside the flat cable.(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.					

No	Item	Criterion
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$
13	TAB	1. Position $\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		2 FPC bonding strength test FPC P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)

	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.
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11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	60°C/ 90%RH	48	and appearance
Temp. Cycle	-30°C ← 25°C →80°C	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting SUNYEE.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

SUNYEE LCDs and modules are not consumer products, but may be incorporated by SUNYEE's customers into consumer products or components thereof, SUNYEE does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of SUNYEE is limited to repair or replacement on the terms set forth below. SUNYEE will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between SUNYEE and the customer, SUNYEE will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with SUNYEE general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.